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Deok-Young JUNG

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: 12-10-2004

2. Name and address of receiving party(ies):

Name: ATLab Inc.

Address: 3rd Floor, Seokam Bldg.

1082-12, Poongduckcheon-ri, Suji-eup

City: Yongin-city State/Prov.: Gyeonggi-do

Country: Republic of Korea ZIP:

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No.

Filing date

B. Patent No.(s)

10/968,535

10-19-2004

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Jae Y. Park

Registration No. PLEASE SEE ATTACHED

Address: Cantor Colburn LLP

55 Griffin Road South

City: Bloomfield State/Prov.: CT

Country: USA ZIP: 06002

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

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PATENT

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ASSIGNMENT

WHEREAS I, **DEOK-YOUNG JUNG** of **5th Fl., Karam Bldg., 1080-14, Pungdeokcheon-ri, Suji-eup, Yongin-city, Gyeonggi-do, Rep. of Korea** (hereinafter referred to as **ASSIGNORS**); have invented

certain new and useful improvements in:

OPTICAL SENSOR CIRCUIT

which claims priority to Republic of Korea Application No. 2003-73199 filed October 20, 2003, for which we are about to file an application for Letters Patent of the United States;

AND WHEREAS, **ATLab Inc.** (hereinafter referred to as **ASSIGNEE**), a corporation organized and existing under the laws of the Country of **Republic of Korea**, having a place of business at **3rd Fl., Seokam Bldg., 1082-12, Poongduckcheon-ri, Suji-eup, Yongin-city, Gyeonggi-do, Republic of Korea**

, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained thereof;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said **ASSIGNORS** have assigned and transferred, and hereby assign and transfer unto the said **ASSIGNEE**, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said **ASSIGNEE**, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of **ASSIGNEE**, its successors and assigns; and We do hereby agree that the said **ASSIGNEE**, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said **ASSIGNEE**, its successors or assigns, and that We will, at the cost and expense of the said **ASSIGNEE** fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further

that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 12/10/2004

 L.S.

DEOK-YOUNG JUNG